Morgan Stanley 4th Annual Technology, Media & Telecoms Conference

November 19, 2004

Dr. Wolfgang ZiebartPresident and CEO
Infineon Technologies AG



Never stop thinking.



Disclaimer

Please note that while you are reviewing this information, this presentation was created as of the date listed, and reflected management views as of that date.

This presentation contains certain forward-looking statements that are subject to known and unknown risks and uncertainties that could cause actual results to differ materially from those expressed or implied by such statements. Such risks and uncertainties include, but are not limited to the Risk Factors noted in the Company's Earnings Releases and the Company's filings with the Securities and Exchange Commission.



Agenda

- Personal Introduction
- Financial Update and Outlook
- Regional Strategy
- **Business Group Highlights**
- Discussion of Integrated Infineon Business Model



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Development FY04 compared to FY03

[EUR m]	FY03	FY04	Change
Net sales Growth (%)	6,152	7,195	1,043 17%
Gross margin	25%	35%	
R&D in % of sales	1,089 18%	1,219 17%	130
SG&A in % of sales	679 11%	718 10%	39
EBIT in % of sales	(299) (5%)	256 4%	555
Therein impairment and antitrust-related charges	(126)	(345)	

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Operating and free cash flow significantly improved

[EUR m]	FY03	FY04
Operating cash flow	730	1,857
Capex	(872)	(1,163)
Other investments ⁽¹⁾	89	(488)
Free cash flow	(53)	206



Outlook for first quarter of fiscal year 2005

- Expectations for a slowdown in several application segments due to higher inventory levels compared to the previous quarters.
- For **automotive electronics**, continuing price pressure and no major changes in demand for semiconductors expected, but weaker market for the **industrial segment**. In combination with seasonal effects, slight reduction in revenues and earnings expected.
- In Wireline Communications no growth expected due to continuing pricing pressure and marketplace inventory corrections. EBIT loss expected to be significantly reduced if and when sale of Fibre Optics to Finisar is closed.
- For **Secure Mobile Solutions** significant reduction in revenues anticipated, driven mainly by market slowdown and higher inventories in the Asian mobile phone market.
- For **Memory Products** business in line with normal seasonal demand expected. Based on additional capacities from Inotera joint venture, Infineon anticipates an increase of bit production.
- Non-recurring US-Dollar 153 million license income from ProMOS agreement expected to positively impact the quarter.

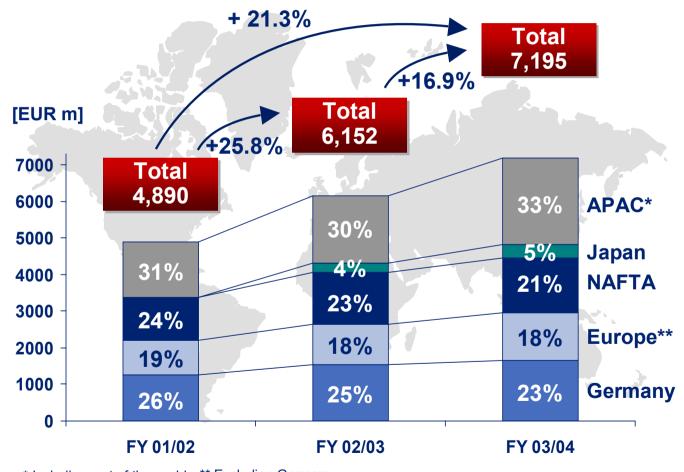


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Strong growth in Asia and Japan



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* Including rest of the world ** Excluding Germany

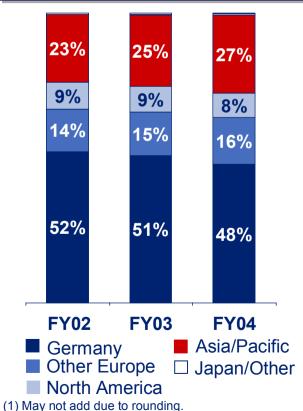
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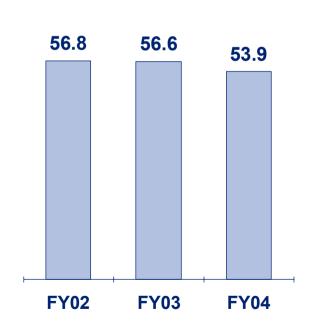


Increasing proportion of employees in lower-cost regions leads to lower personnel expenses



Total personnel expenses per employee [EUR k]





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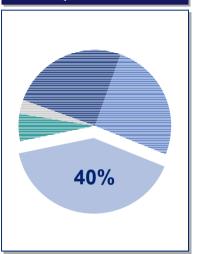
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Memory Products: Significant margin improvement

Revenue share Q4 FY04



Revenues and EBIT margin



- Sequential revenue decrease was mainly caused by a lower ASP and a weakening US-Dollar, which could not be completely compensated by higher sales volumes.
- Sequential EBIT increase before antitrust-related charges was driven by higher bit shipments in combination with cost reductions attributable to a higher 110nm share that was more than offsetting the price decline during the quarter.



110nm technology: In volume production – 90nm and 70nm: At customers and in pipeline

Key facts on 110nm:

- Best wafer yield >93.9%
- Know-how in 193nm litho extended
- All process parameters well established
- More than 80% of all capacities converted to 110nm end FY04

Node	Status	
110nm	- Mass production	
	256M DDR	

Key innovations in 90nm and 70nm:

■ 90nm: - New cell layout

- Trench with HSG fill

Bottle-shaped trench

■ 70nm: - High-κ fill in trench

Node	Status
90nm	- Customer samples from 200mm: 512M DDR
	Transfer to 300m lineRamp-up expectedmid 2005
70nm	- First demonstrators on 300mm: 512M DDR2



110nm: Basis for global 300mm ramp-up in 2005

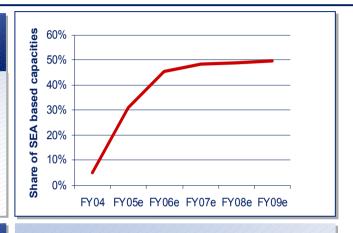




Add resources in South East Asia

Capacities in South East Asia

Based on the additional capacities from SMIC, Inotera and Winbond we plan to increase the share of capacities SEA from around 5% in the current fiscal year to up to 50% in FY07



Development center in Xi'an, China



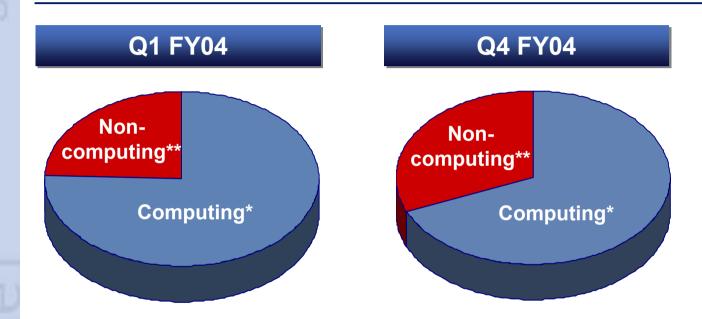
- More than 1,000 engineers planned by 2007
- Close cooperation with local universities for improved know-how transfer
- First product development activities started for memory products

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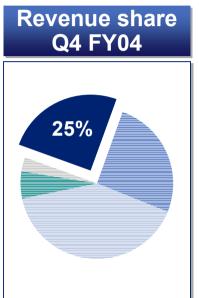
Bit shipment share of non-computing applications increased to more than 30% in Q4 FY04

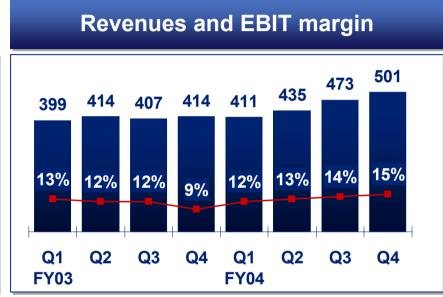


- * Desktop PCs, Notebooks and Workstations; ** Infrastructure, Consumer, Mobile Applications
 - ⇒ A leading supplier to server manufacturers
 - ⇒ Leading with Mobile-RAMs
 - ⇒ Increasing shipments of Graphics RAM
 - Increasing share of shipments for set-top boxes



Automotive & Industrial: Record revenues and stable margins at a high level





- Sequential revenue increase was mostly due to increased sales of products for power management & supply, high-power applications and sensors.
- Sequential EBIT increase reflected primarily higher sales volumes.



Al – Complete coverage of customers' needs

Defining automotive intelligence



Applications:

- Powertrain
- Safety management
- Body & convenience
- Infotainment

Products:

- Sensors
- Microcontrollers
- Power devices
- Wireless chipsets
- Silicon discretes



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Converting and controlling power



Applications:

- AC/DC conversion
- DC/DC conversion
- Consumer drives
- General-purpose drives
- Tuners

Products:

- Sensors
- Microcontrollers
- Thyristors / diodes
- Discrete power
- IGBT modules and bipolar modules
- Power ICs
- Tuner ICs
- Silicon discretes



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Leading positions by increasing market shares in both segments



Infineon Automotive 2003 No. 2 World, No. 1 EU, No. 3 US J ars

Infineon Power 2003* No. 1 World, No. 1 EU, No. 4 US

		2003	2002
1.	Freescale	12.9%	13.4%
2 .	Infineon (2)	8.7%	8.2%
3.	STM	7.6%	6.6%
4.	Renesas	7.0%	n.a.
5.	Bosch	6.4%	5.2%
6.	Toshiba	6.1%	6.2%
7.	NEC	6.0%	6.1%
8.	Philips	5.7%	5.9%

		2003	2002
1.	Infineon (4)	8.1%	6.6%
2.	IR	8.0%	7.6%
3.	STM	7.9%	6.3%
4.	Fairchild	7.4%	6.7%
5.	Toshiba	7.2%	8.6%
6.	Vishay	6.1%	6.3%
7.	Renesas	5.0%	n.a.
8.	Fuji	5.0%	4.0%

■ Market: USD 13.1 bn

■ 5Y CAGR: 7-8%

Source: Strategy Analytics, 2004

■ Market: USD 9.4 bn

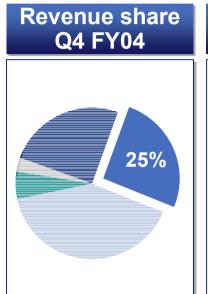
■ 5Y CAGR: 10%

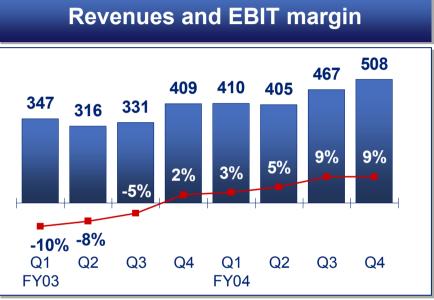
Source: IMS, 2004

^{*} Business Unit "Discrete Power"



Secure Mobile Solutions: Strong revenue growth and EBIT margin improvement





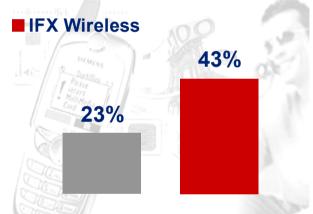
- Sequential revenue improvement was mainly driven by higher demand for mobile solutions. Mobile phone manufacturers have aggressively purchased components in anticipation of a strong holiday season.
- Sequential EBIT increase was mostly due to higher sales volumes, especially of chips for mobile solutions.



Infineon grows faster than the market

IFX Wireless

■ Wireless semiconductor market



Revenue growth CY03 vs. CY02

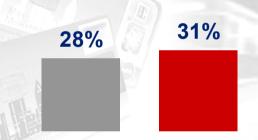
- Improved to No. 3 from No. 5 within one year
- Increased market share to 7.3%

Source: Gartner, June 2004

IFX Chip card

■ Chip card market

■ IFX Chip card



Revenue growth CY03 vs. CY02

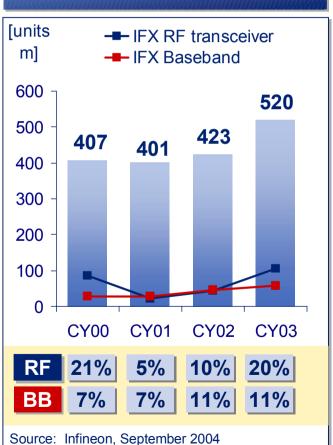
- Clear No. 1; IFX as large as next three competitors combined
- Increased market share to 41.2%

Source: Gartner, April 2004

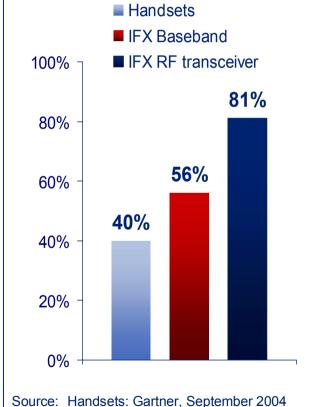


Continued to gain market share in RF and baseband

Total handset market CY00 to CY03



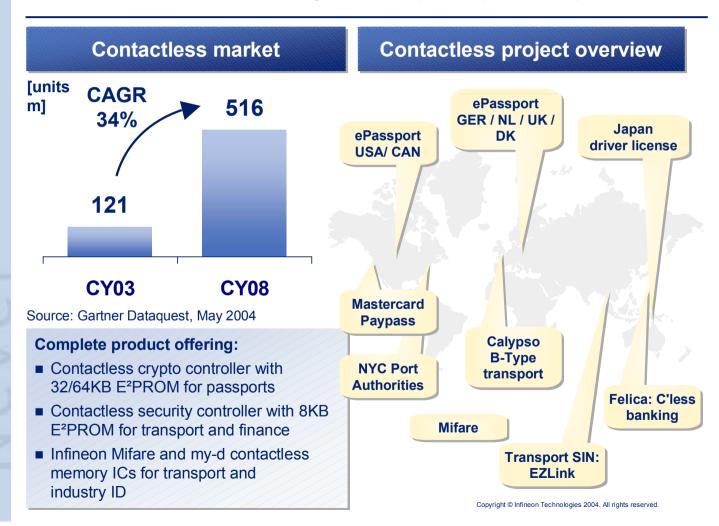
Unit growth 1H CY04 vs. 1H CY03



RF and baseband: Infineon, July 2004



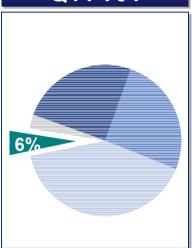
Significant growth potential from a rapidly growing contactless market through a complete product portfolio





Wireline Communications: Strategic measures initiated to achieve profitability





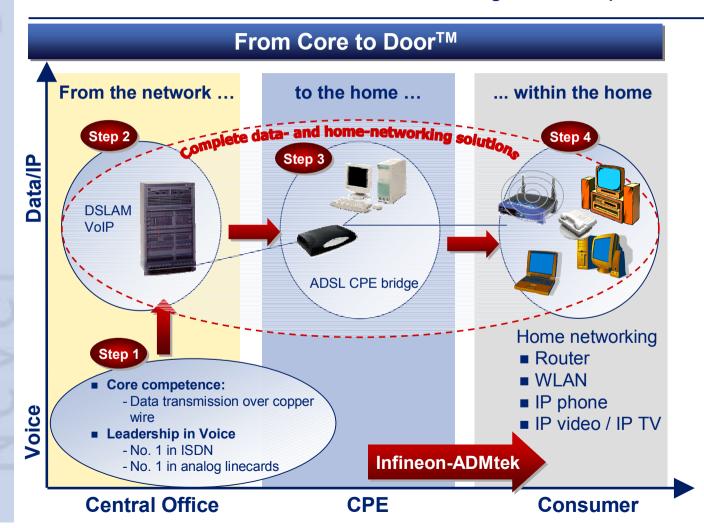
Revenues and EBIT margin



- Sequential revenue increase was mainly driven by higher sales of broadband access ADSL products.
- EBIT loss increased sequentially mainly due to impairment charges of Euro 80 million, predominantly related to the acquisition of Catamaran Communications, Inc.



Transforming from the leading traditional telecom voice vendor into a data- and home-networking solution provider





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Infineon has the technical competencies to target converging markets of the future

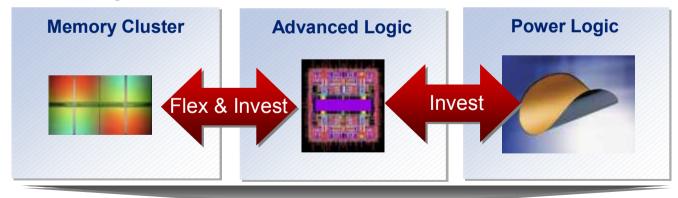
Infineon's exposure to product and industry segments **Application Segments** Data Auto-Consumer Industrial Wireless Wireline **Processing** motive **Application Competencies** DRAM Flash Security / Chipcard **Cellular Phone ICs** RF and Wireless I/O DSL Products / IP telephony **Ethernet over SONET** Ø **Discretes and Tuner Product ICs Power Management** Microcontroller Infineon Sensors **ASICs** Copyright © Infineon Technologies 2004. All rights reserved.



Integrated manufacturing to maximized flexibility and minimized cost

Maximize: Opportunities during market upturns Minimize: Impact of downturns and investments

- Internal flexibility: Between MP and Advanced Logic Cluster
- External flexibility: Silicon foundries and subcontractors
- Cost optimization: Reuse of depreciated equipment for power technologies



Flexibility: Silicon foundries and subcontractors



